

RJU65F28DWA / RJU65F28DWS

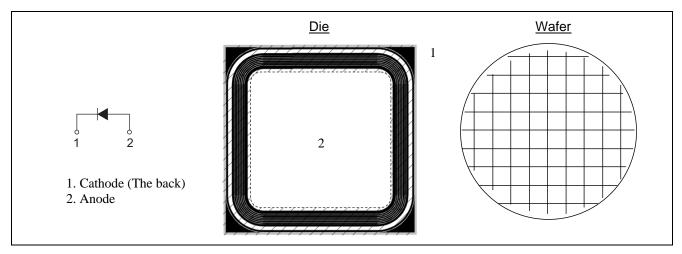
650V - 200A - Fast Recovery Diode Application: Inverter

R07DS1486EJ0201 Rev.2.01 Apr.10.2020

Features

- Low forward voltage
- $V_F = 1.7 V$ typ. (at $I_F = 200 A$, $Tc = 25^{\circ}C$)
- Fast recovery (soft recovery)
- + t_{rr} = 110 ns typ. (at I_F = 100 A, di/dt = 100 A/µs, Tc = 25°C)

Outline



Absolute Maximum Ratings

 $(Tc = 25^{\circ}C \text{ unless otherwise noted})$

			(
Item		Symbol	Ratings	Unit
Maximum reverse voltage		V _{RM}	650	V
Forward current	Tc = 25°C	IF Notes1	400	А
	Tc = 100°C	IF Notes1	200	А
Junction temperature		Tj ^{Notes2}	175	°C

Notes: 1. Depends on thermal properties of assembly.

2. Please use this device in the thermal condition which the junction temperature does not exceed 175 °C. IGBT Application Note is disclosed about reliability test and application condition up to Tj = 175 °C.

Continuous heavy condition (e.g. high temperature/voltage/current or high variation of temperature) may
affect a reliability even if it is within the absolute maximum ratings. Please consider derating condition for
appropriate reliability in reference Renesas Semiconductor Reliability Handbook (Recommendation for
Handling and Usage of Semiconductor Devices) and individual reliability data.



Electrical Characteristics (These data are an actual measurement value in a package.)

 $(Tc = 25^{\circ}C \text{ unless otherwise noted})$

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Forward voltage	VF	_	1.7	2.2	V	IF = 200 A Notes4, Notes5
Reverse current	I _R	—	_	2	μA	$V_R = 650 V^{Notes6}$
Reverse recovery time	trr		110		ns	IF = 100 A, di/dt = 100 A/µs Notes5, Notes7

Notes: 4. Pulse test

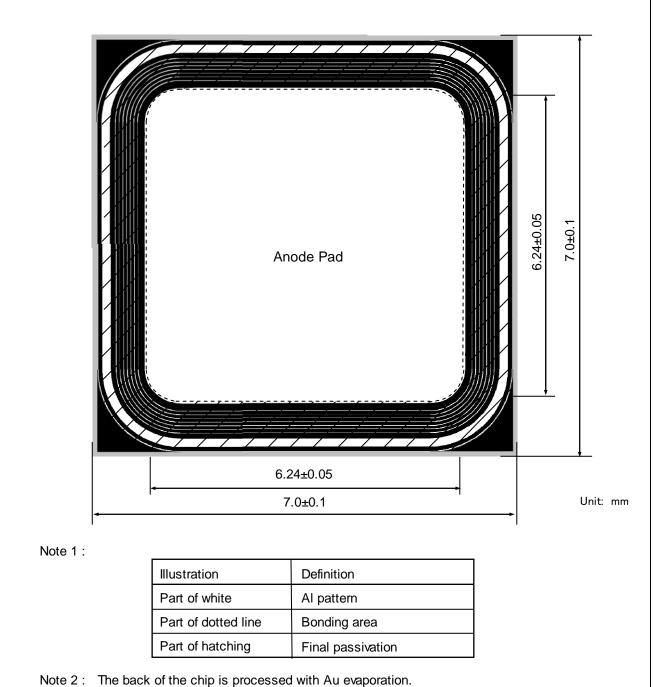
5. Designed target value on Renesas measurement condition. (Not tested)

6. Tested on wafer

7. Tested to be mounted on Renesas single test vehicle.



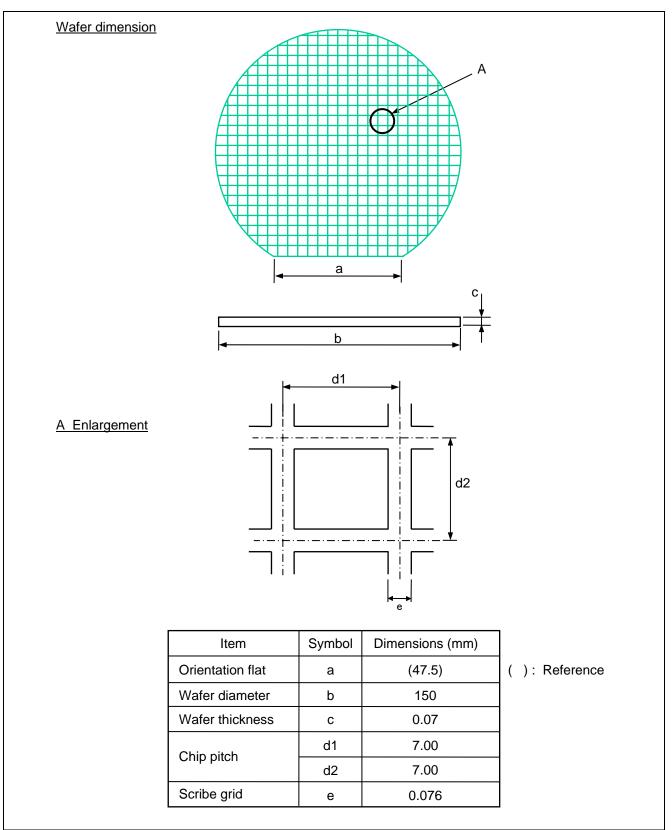
Die Dimension



Note 3 : Recognition, target and any other patterns which are not related to FRD operation, may be changed without notice.



Wafer Dimension



Ordering Information

Orderable Part Number	Shipment form		
RJU65F28DWA-00#W0	Unsawn wafer		
RJU65F28DWS-00#W0	Sawn wafer		



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Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

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